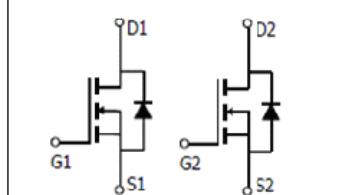
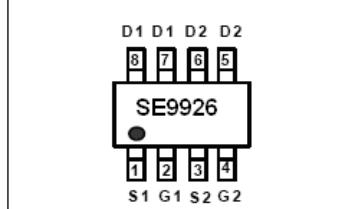


**SE9926****N-Channel Enhancement Mode Field Effect Transistor**

Revision:B

<b>Features</b> <ul style="list-style-type: none"> <li>● <math>V_{DS} = 20V, I_D = 6A</math>  <math>R_{DS(ON)} &lt; 37.5m\Omega @ V_{GS} = 2.5V</math>  <math>R_{DS(ON)} &lt; 27.5m\Omega @ V_{GS} = 4.5V</math></li> <li>● High Power and current handing capability</li> <li>● Lead free product is acquired</li> <li>● Surface Mount Package</li> </ul>	<b>External Dimensions</b>    <p><b>SOP-8 top view</b></p>
<b>Applications</b> <ul style="list-style-type: none"> <li>● Battery protection</li> <li>● Load switch</li> <li>● Power management</li> </ul>	
<b>Construction</b> <ul style="list-style-type: none"> <li>● Silicon epitaxial planer</li> </ul>	

**Absolute maximum ratings (Ta=25°C)**

Parameter	Symbol	Limits	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 10$	V
Drain Current-Continuous@ Current-Pulsed (Note 1)	$I_D$	6	A
	$I_{DM}$	25	A
Maximum Power Dissipation	$P_D$	1.5	W
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 150	°C

**THERMAL CHARACTERISTICS**

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	83	°C/W
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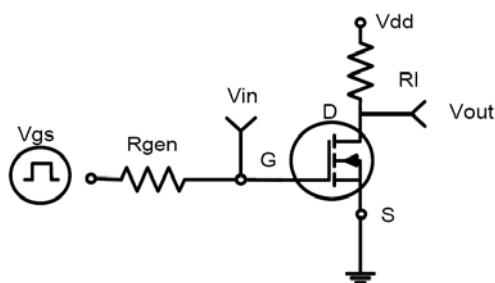
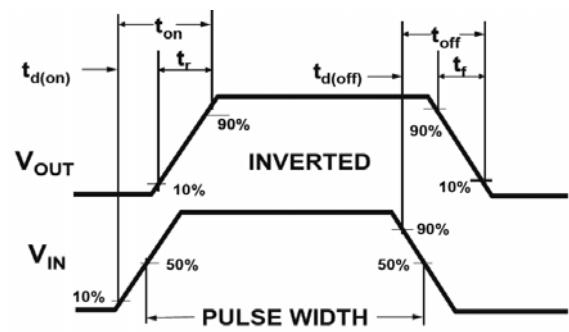
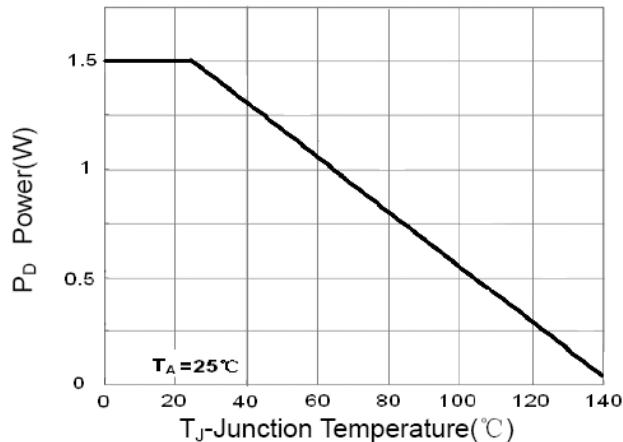
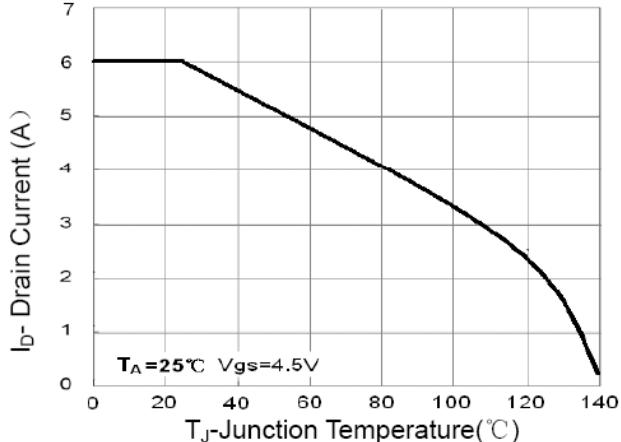
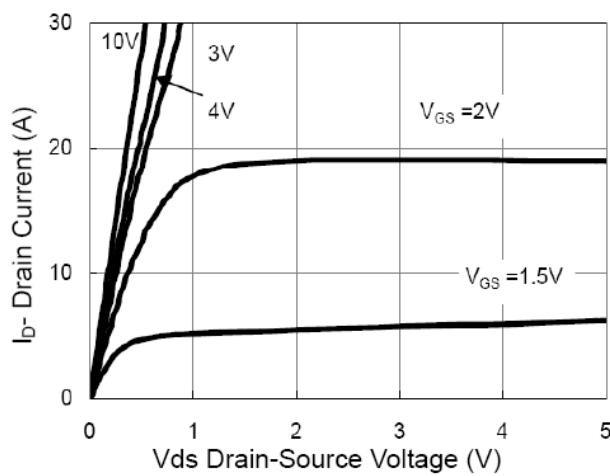
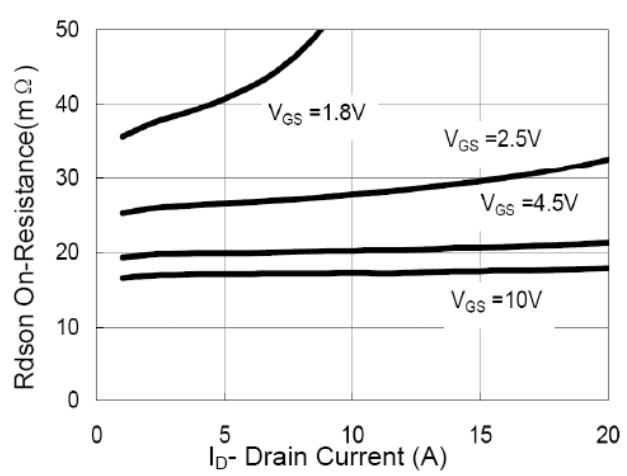
**Electrical characteristics (Ta=25°C)**

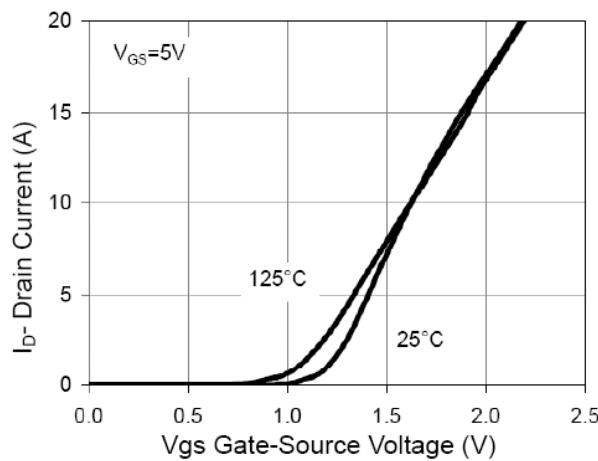
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	20			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 20V, V_{GS} = 0V$			0.8	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 10V, V_{DS} = 0V$			$\pm 80$	nA

ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.45	0.65	1.2	V	
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS} = 4.5V, I_D = 4.5A$		21	27.5	$m\Omega$	
		$V_{GS} = 2.5V, I_D = 3.5A$		30	37.5	$m\Omega$	
Forward Transconductance	$g_{FS}$	$V_{DS} = 5V, I_D = 4.5A$	3			S	
DYNAMIC CHARACTERISTICS (Note 4)							
Input Capacitance	$C_{iss}$	$V_{DS} = 8V, V_{GS} = 0V, F = 1.0MHz$		600		PF	
Output Capacitance	$C_{oss}$			330		PF	
Reverse Transfer Capacitance	$C_{rss}$			140		PF	
SWITCHING CHARACTERISTICS (Note 4)							
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = 10V, I_D = 1A$ $V_{GS} = 4.5V, R_{GEN} = 6\Omega$		10	20	nS	
Turn-on Rise Time	$t_r$			11	25	nS	
Turn-Off Delay Time	$t_{d(off)}$			35	70	nS	
Turn-Off Fall Time	$t_f$			30	60	nS	
Total Gate Charge	$Q_g$	$V_{DS} = 10V, I_D = 6A, V = 4.5V$		10	15	nC	
Gate-Source Charge	$Q_{gs}$			2.3		nC	
Gate-Drain Charge	$Q_{gd}$			3		nC	
DRAIN-SOURCE DIODE CHARACTERISTICS							
Diode Forward Voltage (Note 3)	$V_{SD}$	$V = 0V, I = 1.7A$			1.2	V	
Diode Forward Current (Note 2)	$I_s$			1.7		A	

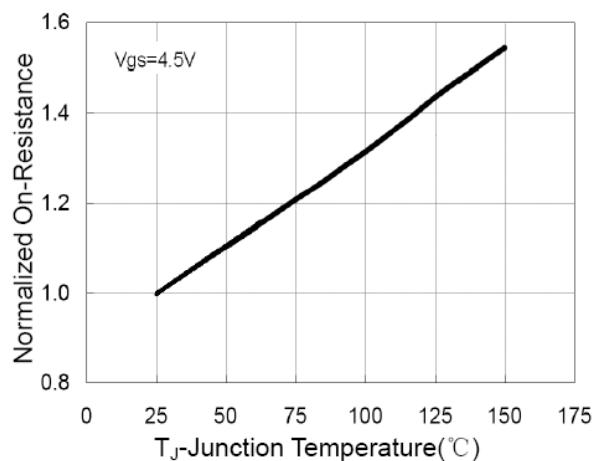
**NOTES:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production testing.

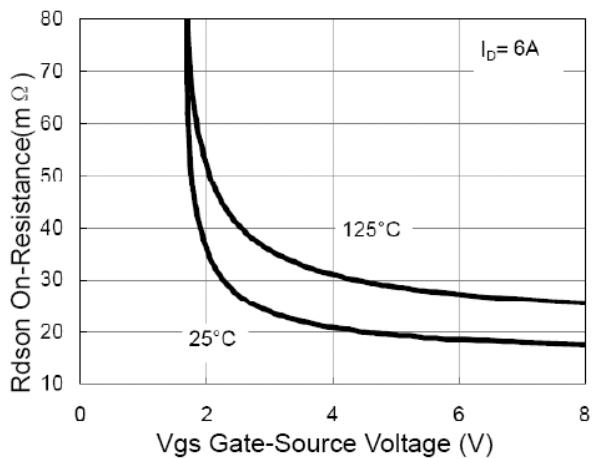
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS****Figure 1:Switching Test Circuit****Figure 2:Switching Waveforms****Figure 3 Power Dissipation****Figure 4 Drain Current****Figure 5 Output CHARACTERISTICS****Figure 6 Drain-Source On-Resistance**



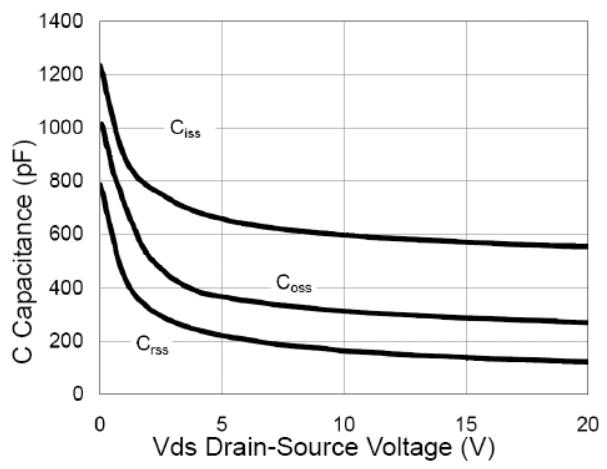
**Figure 7 Transfer Characteristics**



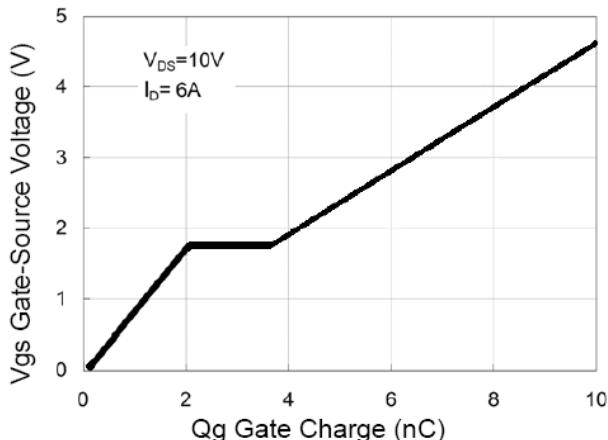
**Figure 8 Drain-Source On-Resistance**



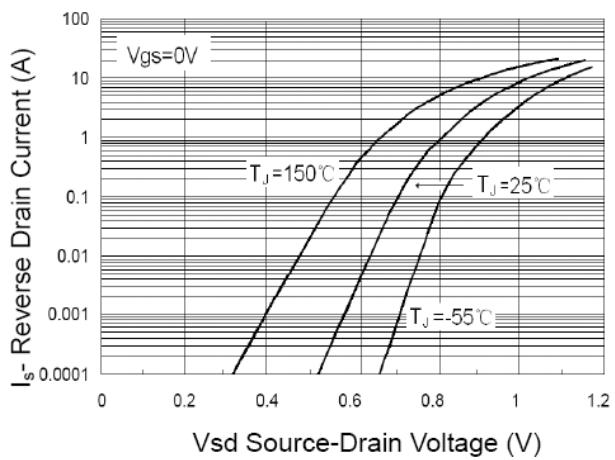
**Figure 9  $R_{DSON}$  vs  $V_{GS}$**



**Figure 10 Capacitance vs  $V_{DS}$**



**Figure 11 Gate Charge**



**Figure 12 Source-Drain Diode Forward**

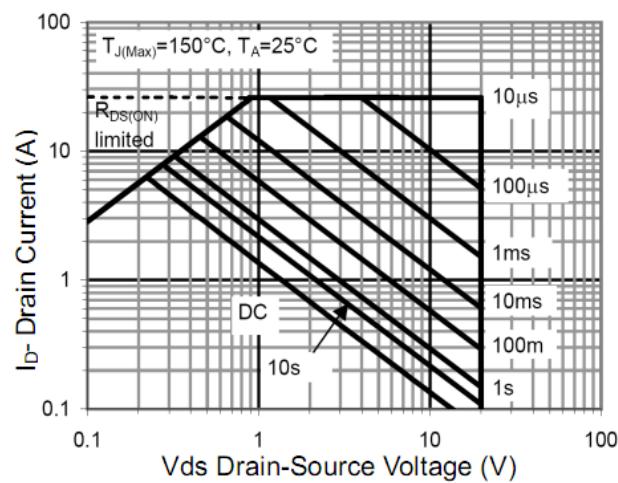


Figure 13 Safe Operation Area

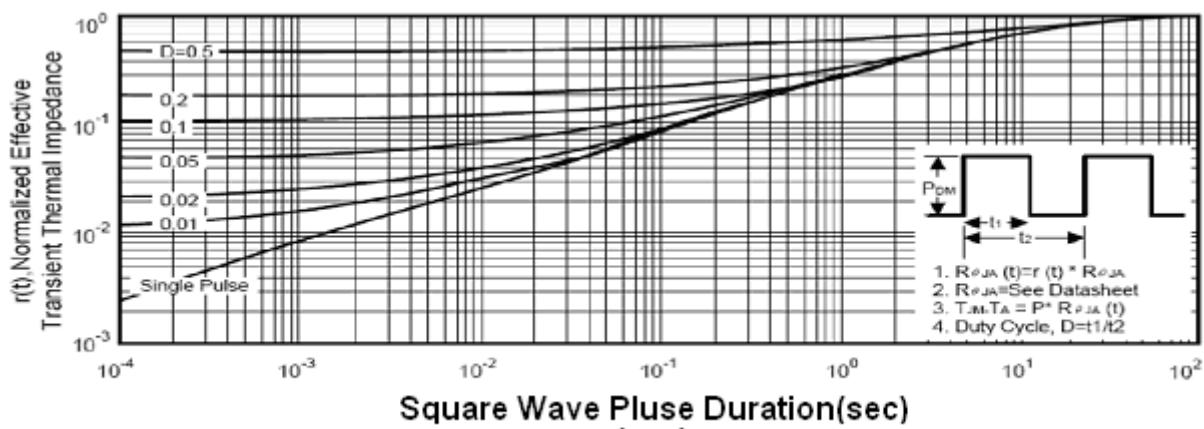
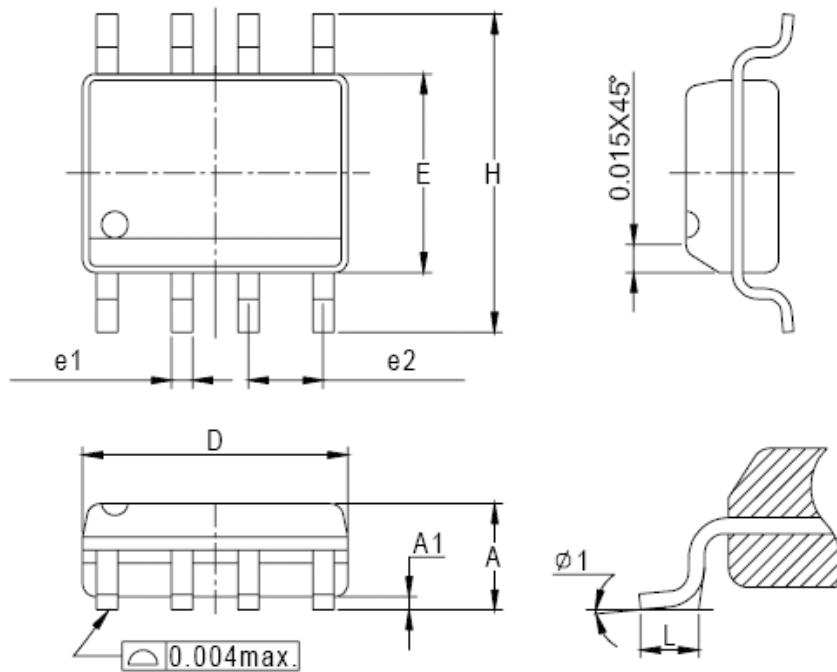


Figure 14: Normalized Maximum Transient Thermal Impedance

## Packaging Information

SOP-8 pin



Dim	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
D	4.80	5.00	0.189	0.197
E	3.80	4.00	0.150	0.157
H	5.80	6.20	0.228	0.244
L	0.40	1.27	0.016	0.050
e1	0.33	0.51	0.013	0.020
e2	1.27BSC		0.50BSC	
φ 1	8°		8°	

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